

General Description

The MAX9930 evaluation kit (EV kit) is a fully assembled and tested surface-mount printed-circuit board (PCB) that evaluates the MAX9930 RF-detecting controller. The MAX9930 EV kit includes on-board shutdown control, as well as quasi-measurement mode circuitry to provide an easy method to evaluate the MAX9930. The RF input utilizes a 50Ω SMA connector for convenient connection to test equipment.

The MAX9930 EV kit comes with the MAX9930EUA+ installed, but can also be used to evaluate the MAX9931/MAX9932 RF-detecting controllers and the MAX9933 RF detector. To evaluate the MAX9931, MAX9932, or MAX9933, request a MAX9931EUA+, a MAX9932EUA+, or a MAX9933EUA+ free sample with the MAX9930 EV kit.

Features

- ♦ 2.7V to 5.25V Single-Supply Operation
- ♦ 50Ω SMA Connector on RF Input
- ♦ On-Board Quasi-Measurement Mode Circuitry
- ♦ On-Board Shutdown Control
- ♦ Fully Assembled and Tested Surface-Mount PCB

Ordering Information

PART	TEMP RANGE	IC PACKAGE
MAX9930EVKIT+	0°C to +70°C*	8 μMAX [®]

⁺Denotes a lead-free and RoHS-compliant EV kit.

Component List

DESIGNATION	QTY	DESCRIPTION
C1	1	33pF ±5%, 50V C0G ceramic capacitor (0402) TDK C1005C0G1H330J Taiyo Yuden UMK105CG330JV
C2, C4	2	100pF ±5%, 50V C0G ceramic capacitors (0402) TDK C1005COG1H101J Taiyo Yuden UMK105CG101JW
C3	1	2200pF ±10%, 50V X7R ceramic capacitor (0402) TDK C1005X7R1H222K Taiyo Yuden UMK105BJ222KW
C5, C7, C8	3	0.1µF ±10%, 10V X5R ceramic capacitors (0402) TDK C1005X5R1A104K Taiyo Yuden LMK105BJ104KV
C6	0	Not installed, capacitor (0402)
C9	1	22nF ±10%, 16V X7R ceramic capacitor (0402) TDK C1005X7R1C223K Taiyo Yuden EMK105BJ223KV

DESIGNATION	QTY	DESCRIPTION
JU1, JU2	2	3-pin headers
JU3	1	2-pin header
R1	1	52.3Ω ±1% resistor (0402)
R2	1	0Ω ±5% resistor (0402)
R3	0	Not installed, resistor (0402)
R4, R5, R8	3	10kΩ ±1% resistors (0402)
R6	1	100Ω ±1% resistor (0402)
R7	1	14kΩ ±1% resistor (0402)
RFIN	1	SMA connector (PC edge mount)
U1	1	MAX9930EUA+ (8-pin μMAX)
U2	1	Maxim high-output drive op amp MAX4412EXK+ (5-pin SC70)
_	3	Shunts
_	1	PCB: MAX9930 Evaluation Kit+

Component Suppliers

SUPPLIER	PHONE	WEBSITE
Taiyo Yuden	800-348-2496	www.t-yuden.com
TDK Corp.	847-803-6100	www.component.tdk.com

Note: Indicate that you are using the MAX9930 when contacting these component suppliers.

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^{*}This limited temperature range applies to the EV kit PCB only. The MAX9930 IC temperature range is -40°C to +85°C.

Quick Start

Recommended Equipment

Before beginning, the following equipment is needed:

- One variable DC power supply capable of supplying between 2.7V and 5.25V at 50mA
- One signal generator capable of delivering -45dBm to +0dBm at frequencies between 2MHz and 1.6GHz
- One voltmeter

Procedure

The MAX9930 EV kit is fully assembled and tested. Follow the steps below to verify board operation. Caution: Do not turn on the power supply until all connections are completed.

- 1) Set the variable DC power supply to 3V.
- Ensure that the variable DC power supply is turned off.
- Connect the positive terminal of the variable DC power supply to the pad marked VCC. Connect the ground return of the variable DC power supply to the pad marked GND.
- 4) Set the signal generator to produce an output signal of 0dBm at a frequency of 50MHz.
- 5) Ensure that the signal generator is turned off.
- 6) Connect the signal generator to the edge-mount SMA connector marked RFIN.
- Connect the positive terminal of the voltmeter to the pad marked SET. Connect the ground return of the voltmeter to the pad marked GND.
- 8) Ensure that a shunt is installed across pins 1-2 of jumper JU1.
- 9) Ensure that a shunt is installed across pins 2-3 of jumper JU2.
- 10) Ensure that a shunt is installed across jumper JU3.
- 11) Turn on the variable DC power supply.
- 12) Turn on/enable the output of the signal generator.
- 13) Verify with the voltmeter that an output voltage of approximately 1.4V is produced between the SET pad and the GND pad.

Detailed Description

The MAX9930 EV kit is a fully assembled and tested surface-mount PCB that evaluates the MAX9930 RF-detecting controller. The MAX9930 EV kit can also be used to evaluate the MAX9931/MAX9932 RF-detecting controllers and the MAX9933 RF detector. The MAX9930 EV kit includes on-board shutdown control, as well as quasi-measurement mode circuitry to provide an easy method to evaluate the MAX9930, MAX9931, and MAX9932. The RF input utilizes a 50Ω SMA connector for convenient connection to test equipment.

For operation in controller mode, both JU2 and JU3 should be removed. Use a DAC or external precision voltage supply to apply the set-point voltage to the SET pad. RFIN is connected to the RF source—power amplifier (PA) output through a directional coupler—and the OUT pad is connected to the gain-control pin of the PA. When used in controller mode, a capacitor must be installed in C3 for loop stability (see the *Filter Capacitor Selection* section).

To simulate an automatic gain-control (AGC) loop, a quasi-measurement mode can be implemented where the MAX9930 delivers an output voltage that is proportional to the log of the input signal (see the *Quasi-Measurement Mode* section). To establish the transfer function of the log amp, the RF input power level should be swept while the voltage at the SET pad is measured. This is the simplest method to validate operation of the evaluation board.

Shutdown Control

Jumper JU1 controls the CMOS-compatible shutdown pin (SHDN) of the MAX9930, which disables the MAX9930. Removing the shunt from JU1 allows the SHDN pin to be driven with an external signal source connected to the SHDN pad (see Table 1 for shutdown shunt positions).

Table 1. Shutdown Selection

JUMPER	SHUNT POSITION	DESCRIPTION
	1-2*	MAX9930 enabled
JU1	2-3	MAX9930 disabled
JU1 =	Not installed	SHDN pin driven by an external signal source

^{*}Default position.

Quasi-Measurement Mode

Enabling the quasi-measurement mode changes the MAX9930 EV kit function from a PA controller to a log detector. This mode allows for easy measurement of RFIN versus the SET voltage and these measurements can then be used to find the intercept and slope required for the given application.

Place a shunt on pins 2-3 of JU2 and install a shunt across JU3 to enable the quasi-measurement mode. This configuration connects the OUT voltage through an inverting op amp to the SET pin. The quasi-measurement mode yields a nominal relationship between RFIN and SET. See Table 2 for quasi-measurement mode shunt positions.

Table 2. Quasi-Measurement Mode Selection

SHUNT POSITION		QUASI-MEASUREMENT MODE
JU2	JU3	QUASI-MEASUREMENT MODE
1-2	X	Disabled
2-3*	Installed*	Enabled
X	Not installed	Disabled
Not installed	Χ	Disabled

^{*}Default position.

X = a "don't care" position.

Filter Capacitor Selection

When functioning as a PA controller, the MAX9930 requires some capacitance to maintain loop stability. Global Satellite Mobile (GSM) applications require a control-loop bandwidth of at least 150kHz. A 2200pF capacitor (C4) is installed to obtain this control-loop

bandwidth. Refer to the Gain and Phase vs. Frequency graph in the *Applications Information* section of the MAX9930/MAX9931/MAX9932 IC data sheet for alternative capacitor values.

Evaluating the MAX9931/MAX9932

The MAX9930 can be replaced with the MAX9931 to allow an input range of -35dBm to +10dBm into 50Ω , or with the MAX9932 to allow an input range of -30dBm to +15dBm into 50Ω . Replace U1 with a MAX9931EUA+ or MAX9932EUA+.

Evaluating the MAX9933

The MAX9930 can be replaced with the MAX9933 to allow an input range of -45dBm to +0dBm into 50Ω . Replace U1 with a MAX9933EUA+. Once a MAX9933 IC is installed on U1, remove the shunt on JU3 to disconnect the quasi-measurement mode circuitry. Place the shunt on pins 1-2 of JU2 to connect pin 3 of the MAX9933 to ground. The voltage on the OUT pad reflects the power level of the RF input signal.

Layout Considerations

A good PCB layout is an essential part of RF circuit design. The MAX9930EV kit PCB can serve as a guide for laying out a board using the MAX9930–MAX9933. Keep traces carrying RF signals as short as possible to minimize radiation and insertion loss due to the PCB. Each VCC node on the PCB should have its own decoupling capacitor. This minimizes supply coupling from one section of the PCB to another. Using a star topology for the supply layout, in which each VCC node in the circuit has a separate connection to the central VCC node, can further minimize coupling between sections of the PCB.

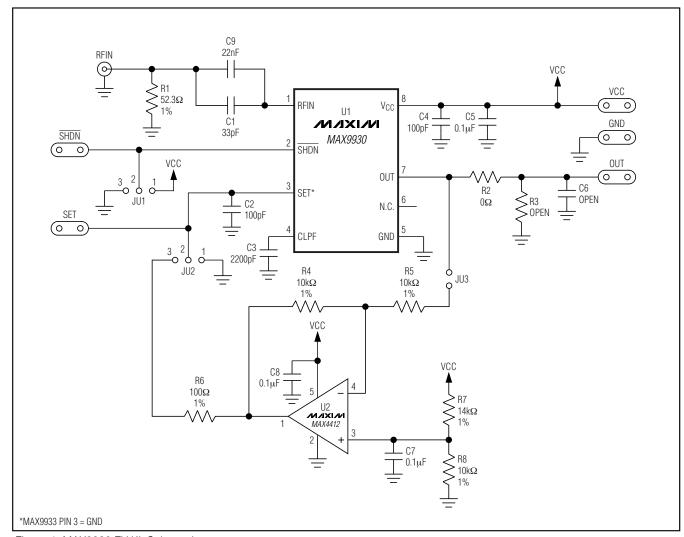


Figure 1. MAX9930 EV Kit Schematic

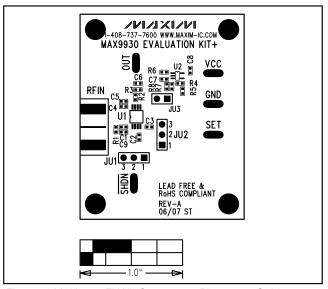


Figure 2. MAX9930 EV Kit Component Placement Guide—Component Side

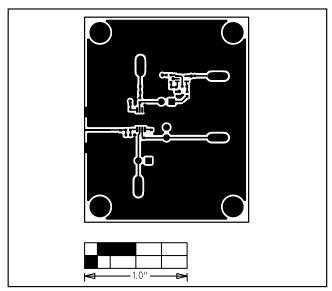


Figure 3. MAX9930 EV Kit PCB Layout—Component Side

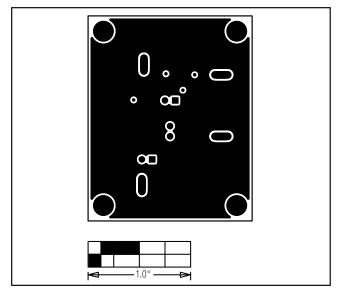


Figure 4. MAX9930 EV Kit PCB Layout—Ground Plane on Layer 2

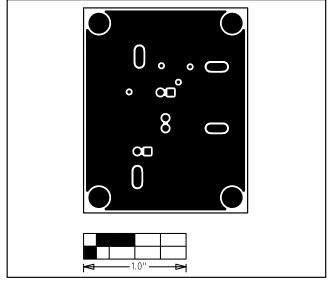


Figure 5. MAX9930 EV Kit PCB Layout—Ground Plane on Layer 3

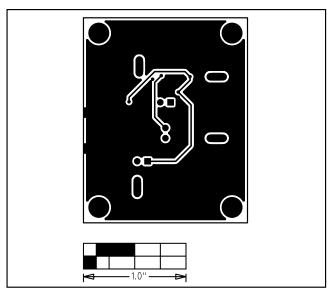


Figure 6. MAX9930 EV Kit PCB Layout—Solder Side